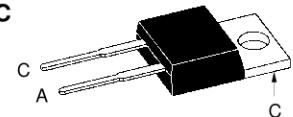


Fast Recovery Epitaxial Diode (FRED)

DSEI 20

I_{FAVM} = 17 A
V_{RRM} = 1200 V
t_{rr} = 40 ns

V _{RSM} V	V _{RRM} V	Type
1200	1200	DSEI 20-12A



A = Anode, C = Cathode

Symbol	Test Conditions		Maximum Ratings	
I _{FRMS}	T _{VJ} = T _{VJM}		70	A
I _{FAVM} ①	T _C = 85°C; rectangular, d = 0.5		17	A
I _{FRM}	t _p < 10 µs; rep. rating, pulse width limited by T _{VJM}		220	A
I _{FSM}	T _{VJ} = 45°C; t = 10 ms (50 Hz), sine		130	A
	t = 8.3 ms (60 Hz), sine		140	A
	T _{VJ} = 150°C; t = 10 ms (50 Hz), sine		110	A
	t = 8.3 ms (60 Hz), sine		120	A
I ² t	T _{VJ} = 45°C	t = 10 ms (50 Hz), sine	85	A ² s
		t = 8.3 ms (60 Hz), sine	80	A ² s
	T _{VJ} = 150°C; t = 10 ms (50 Hz), sine		60	A ² s
		t = 8.3 ms (60 Hz), sine	60	A ² s
T _{VJ}			-40...+150	°C
T _{VJM}			150	°C
T _{stg}			-40...+150	°C
P _{tot}	T _C = 25°C		78	W
M _d	Mounting torque		0.4...0.6	Nm
Weight			2	g

Symbol	Test Conditions		Characteristic Values	
	typ.		max.	
I _R	T _{VJ} = 25°C	V _R = V _{RRM}	750	µA
	T _{VJ} = 25°C	V _R = 0.8 • V _{RRM}	250	µA
	T _{VJ} = 125°C	V _R = 0.8 • V _{RRM}	7	mA
V _F	I _F = 12 A;	T _{VJ} = 150°C	1.87	V
		T _{VJ} = 25°C	2.15	V
V _{To}	For power-loss calculations only		1.65	V
r _T	T _{VJ} = T _{VJM}		18.2	mΩ
R _{thJC}			1.6	K/W
R _{thJA}			60	K/W
t _{rr}	I _F = 1 A; -di/dt = 100 A/µs; V _R = 30 V; T _{VJ} = 25°C	40	60	ns
I _{RM}	V _R = 540 V; I _F = 20 A; -di _F /dt = 100 A/µs	7		A
	L ≤ 0.05 µH; T _{VJ} = 100°C			

① I_{FAVM} rating includes reverse blocking losses at T_{VJM}, V_R = 0.8 V_{RRM}, duty cycle d = 0.5
Data according to IEC 60747

IXYS reserves the right to change limits, test conditions and dimensions

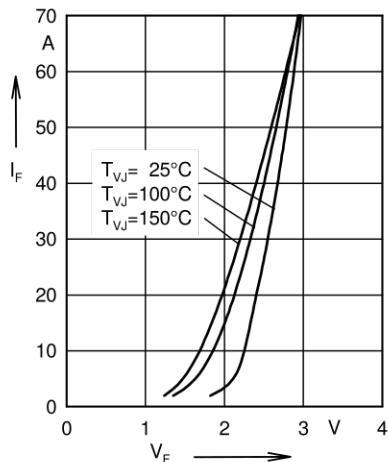


Fig. 1 Forward current versus voltage drop.

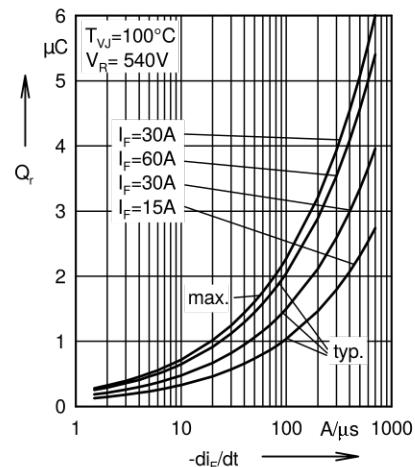


Fig. 2 Recovery charge versus $-di_F/dt$.

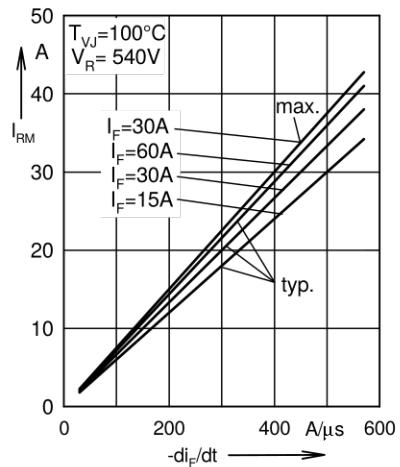


Fig. 3 Peak reverse current versus $-di_F/dt$.

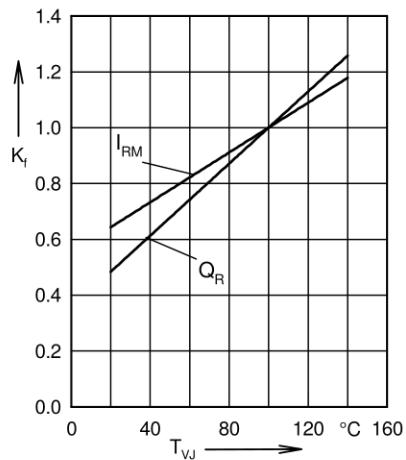


Fig. 4 Dynamic parameters versus junction temperature.

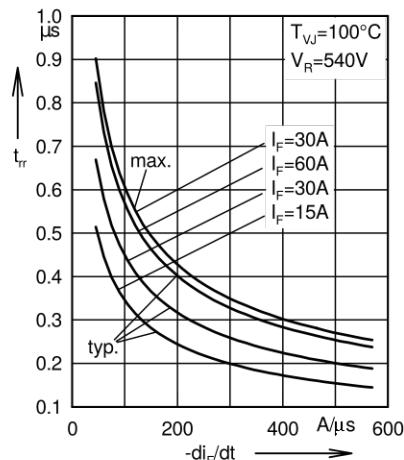


Fig. 5 Recovery time versus $-di_F/dt$.

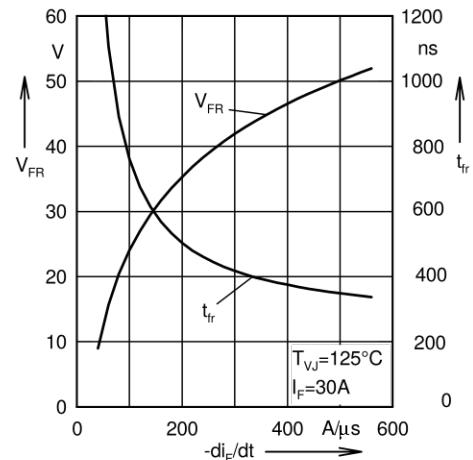


Fig. 6 Peak forward voltage versus $-di_F/dt$.

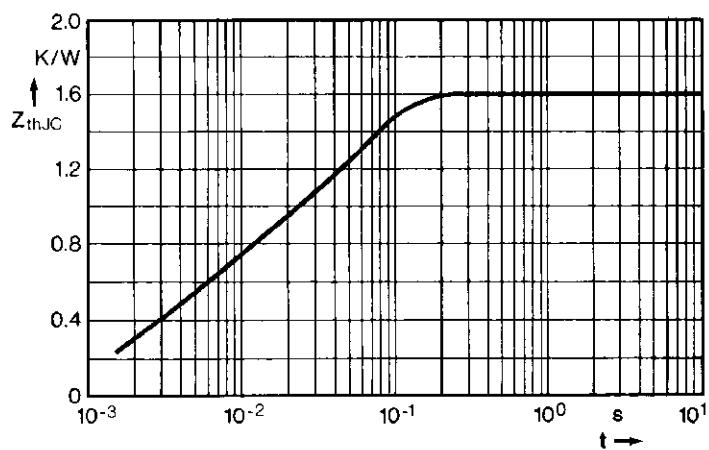
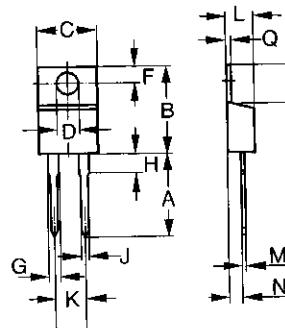


Fig. 7 Transient thermal impedance junction to case.

Dimensions



Dim.	Millimeter Min.	Millimeter Max.	Inches Min.	Inches Max.
A	12.70	14.73	0.500	0.580
B	14.23	16.51	0.560	0.650
C	9.66	10.66	0.380	0.420
D	3.54	4.08	0.139	0.161
E	5.85	6.85	0.230	0.420
F	2.54	3.42	0.100	0.135
G	1.15	1.77	0.045	0.070
H	-	6.35	-	0.250
J	0.64	0.89	0.025	0.035
K	4.83	5.33	0.190	0.210
L	3.56	4.82	0.140	0.190
M	0.38	0.56	0.015	0.022
N	2.04	2.49	0.080	0.115
Q	0.64	1.39	0.025	0.055